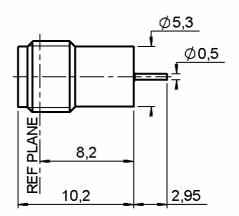
R125.630.000

HERMETIC-WITH CYLINDRICAL CONTACT

Series: SMA







All dimensions are in mm.



 COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	FERRO-NICKEL DILVER P - PTFE	GOLD 0.5 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2

Issue: 1220 E

In the effort to improve our products, we reserve the right to make changes judged to be



R125.630.000

HERMETIC-WITH CYLINDRICAL CONTACT

5000 MΩ mini

Series: SMA

PACKAGING

Standard	Unit	Other
1	-	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance **50** Ω Frequency **0-18** GHz

VSWR

1.10 + **0.0100** x F(GHz) Maxi Insertion loss **0.3*** $\sqrt{F(GHz)}$ dB Maxi

NA - F(GHz)) dB Maxi RF leakage - (

Voltage rating 500 Veff Maxi Dielectric withstanding voltage 1000 Veff mini

ENVIRONMENTAL

Operating temperature -40/+100 ° C

Hermetic seal **10-5** Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

* Coaxial Transmission Line Only

MECHANICAL CHARACTERISTICS

Center contact retention

Insulation resistance

Axial force – Mating end 27 N mini Axial force – Opposite end 27 N mini Torque NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **1,2000** g

Issue: 1220 E

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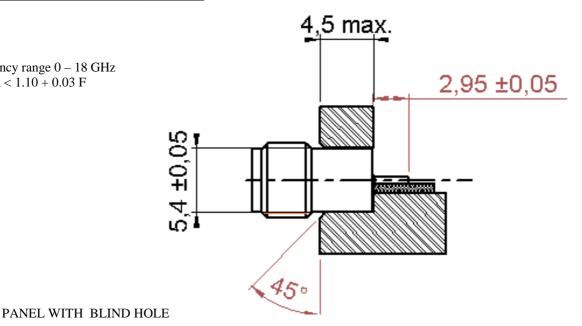
HERMETIC-WITH CYLINDRICAL CONTACT

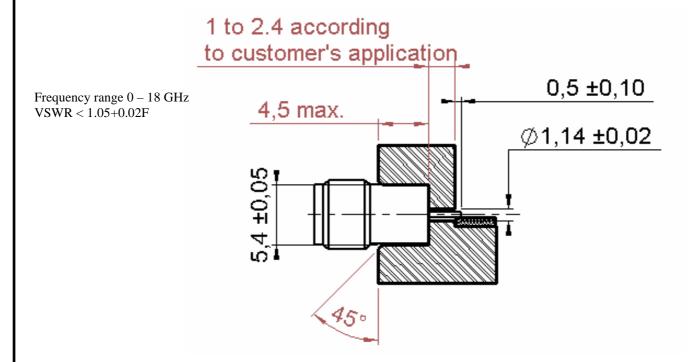
Series: SMA

RECOMMENDED MOUNTING HOLE DETAIL

PANEL WITH THROUGH HOLE

Frequency range 0 – 18 GHz VSWR < 1.10 + 0.03 F





Issue: 1220 E

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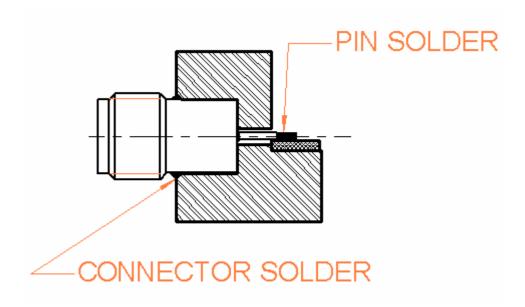


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HERMETIC-WITH CYLINDRICAL CONTACT

Series: SMA

MOUNTING INSTRUCTIONS



- 1 Degrease and clean connector and box.
- 2 –Solder the connector on the panel:

Preheating at about 100°c.

Take care not to exceed 250°c during solder operation.

- 3 –Solder the pin on the track:
 - -ceramic substrates: preheating at about 100°c.
 - -other substrates: no preheating required.

NOTE: Please use a small soldering iron ,or hot air soldering system.

Issue: 1220 E

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